

PNP -100mA -50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value
V <sub>CC</sub>	-50V
I <sub>C(MAX.)</sub>	-100mA
R <sub>1</sub>	2.2kΩ
$R_2$	10kΩ

## Features

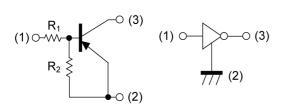
- 1) Built-In Biasing Resistors,  $R_1 = 2.2k\Omega$ ,  $R_2 = 10k\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Types: DTC123Y series

## Application

INVERTER, INTERFACE, DRIVER

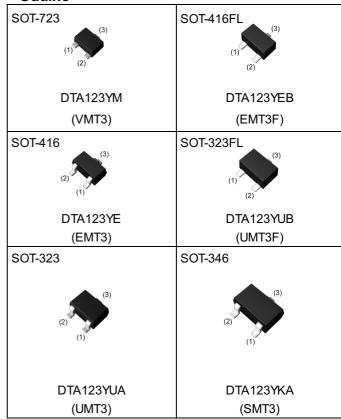
#### Inner circuit

DTA123YM/ DTA123YEB/ DTA123YUB

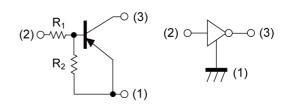


- (1) IN (BASE)
- (2) GND (+) (EMITTER)
- (3) OUT (COLLECTOR)

## Outline



## DTA123YE/ DTA123YUA/ DTA123YKA



- (1) GND (+) (EMITTER)
- (2) IN (BASE)
- (3) OUT (COLLECTOR)

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTA123YM	SOT-723	1212	T2L	180	8	8000	52
DTA123YEB	SOT-416FL	1616	TL	180	8	3000	52
DTA123YE	SOT-416	1616	TL	180	8	3000	52
DTA123YUB	SOT-323FL	2021	TL	180	8	3000	52
DTA123YUA	SOT-323	2021	T106	180	8	3000	52
DTA123YKA	SOT-346	2928	T146	180	8	3000	52

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Pa	arameter	Symbol	Values	Unit
Supply voltage		V <sub>CC</sub>	-50	V
Input voltage			-12 to 5	V
Output current			-100	mA
Collector current			-100	mA
	DTA123YM		150	
	DTA123YEB		150	\Δ/
Davis a dia ain atia a	DTA123YE	P <sub>D</sub> *2	150	
Power dissipation	DTA123YUB	P <sub>D</sub> -	200	mW
	DTA123YUA		200	
	DTA123YKA		200	
Junction temperature		T <sub>j</sub>	150	°C
Range of storage temperate	ure	T <sub>stg</sub>	-55 to +150	°C

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Parameter	Symbol		Min.	Тур.	Max.	Offic
Input voltage	$V_{l(off)}$	$V_{CC} = -5V, I_{O} = -100 \mu A$	-	-	-0.3	V
Input voltage	V <sub>I(on)</sub>	$V_O = -0.3V$ , $I_O = -20$ mA	-3.0	-	-	V
Output voltage	V <sub>O(on)</sub>	$I_O = -10$ mA, $I_I = -0.5$ mA	1	-100	-300	mV
Input current	I <sub>I</sub>	V <sub>I</sub> = -5V	1	-	-3.8	mA
Output current	I <sub>O(off)</sub>	$V_{CC} = -50V, V_{I} = 0V$	1	-	-500	nA
DC current gain	G <sub>I</sub>	$V_{O} = -5V, I_{O} = -10mA$	33	-	-	-
Input resistance	R <sub>1</sub>	-	1.54	2.2	2.86	kΩ
Resistance ratio	R <sub>2</sub> /R <sub>1</sub>	-	3.6	4.5	5.5	-
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = -10V, I <sub>E</sub> = 5mA, f = 100MHz	-	250	-	MHz

<sup>\*1</sup> Characteristics of built-in transistor

<sup>\*2</sup> Each terminal mounted on a reference land.

## ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

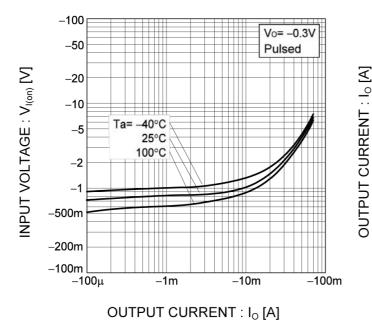


Fig.2 Output current vs. input voltage (OFF characteristics)

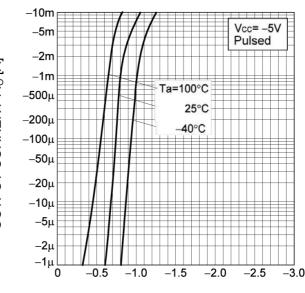


Fig.3 Output current vs. output voltage

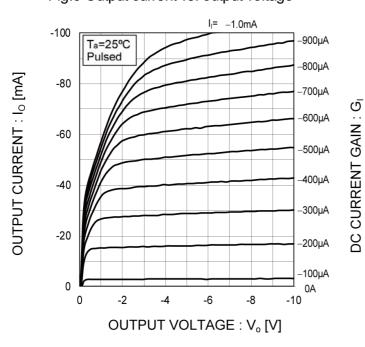
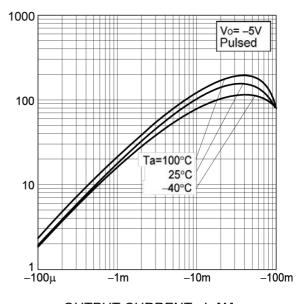


Fig.4 DC current gain vs. output current

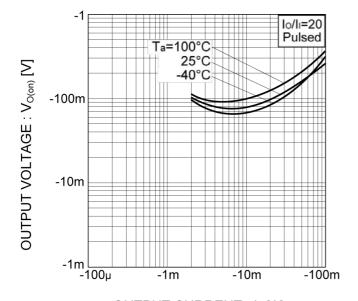
INPUT VOLTAGE :  $V_{I(off)}[V]$ 



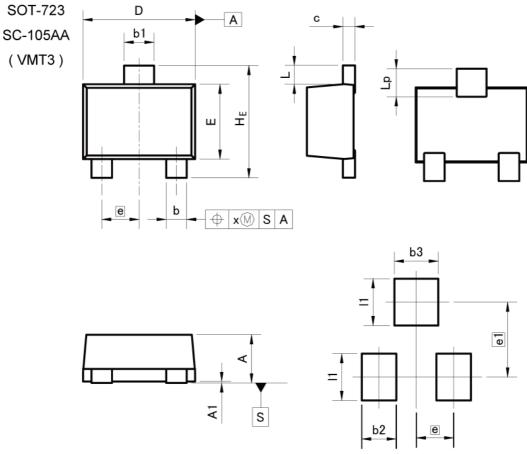
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# ●Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.5 Output voltage vs. output current



OUTPUT CURRENT :  $I_o$  [A]



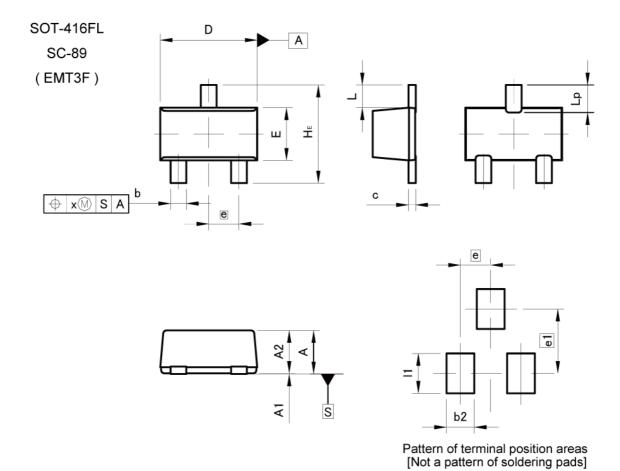
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES	
1000	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.40		0.0	02
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
х	#	0.10	<u> </u>	0.004

DIM	MILIM	MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
b2	<del>11</del> 0	0.37	544	0.015
b3	226	0.47	822	0.019
e1	0.	80	0.031	
11	<del>5</del> 8	0.50	200	0.020

Dimension in mm/inches



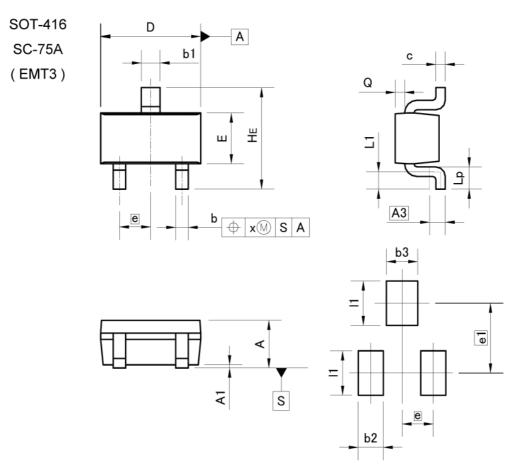


DIM -	MILIM	ETERS	INC	HES
DIM L	MIN	MAX	MIN	MAX
Α	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.9	50	0.0	20
HE	1.50	1.70	0.059	0.067
L	0.3	37	0.0	15
Lp	0.35	0.55	0.014	0.022
х		0.10	-	0.004

DIM	MILIMETERS		INCHES	
DIM [	MIN	MAX	MIN	MAX
b2	<del>=</del> 8	0.46	-	0.018
e1		1.05	_	0.041
11	#	0.65		0.026

Dimension in mm/inches





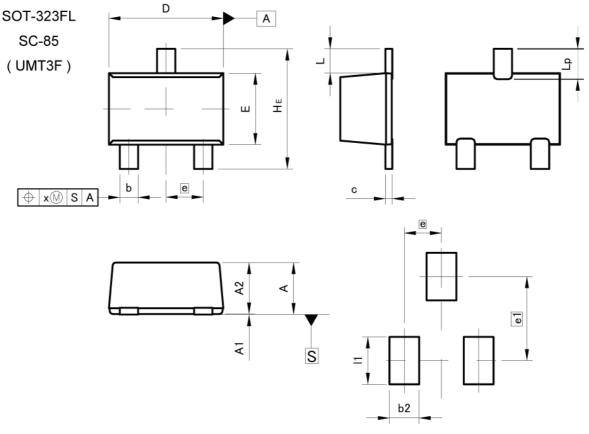
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.:	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.50 0.02		20	
HE	1.40	1.80	0.055	0.071
L1	0.10	#3	0.004	÷
Lp	0.15		0.006	255
Q	0.05	0.25	0.002	0.010
х	15 <del>-5</del>	0.10	-	0.004

DIM	MILIMETERS		INCHES	
DIM L	MIN	MAX	MIN	MAX
b2	244	0.40	-	0.016
b3	10 <del>48</del>	0.50	; <del>; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; </del>	0.020
e1	1.	1.10		043
11		0.70	-	0.028

Dimension in mm/inches





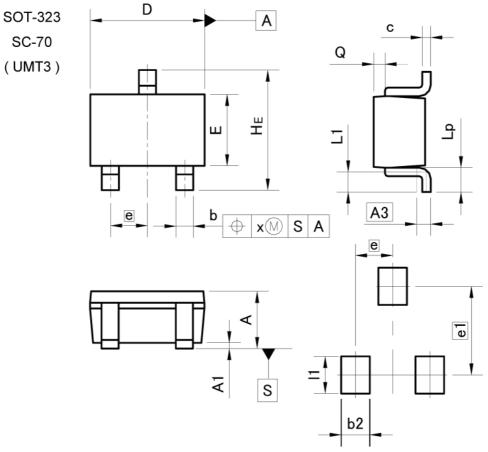
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM -	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
С	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	0.65 0.026		26
HE	2.00	2.20	0.079	0.087
L	0.425		0.0	17
Lp	0.43	0.63	0.017	0.025
х	==:	0.10	-	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	=:	0.52	_	0.020
e1	1.47		0.0	058
11	<del></del>	0.83	_	0.033

Dimension in mm/inches





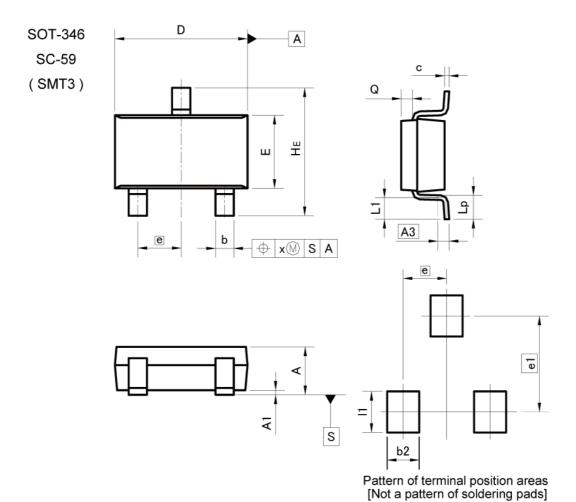
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65		0.026	
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	-	0.10	-	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	<u>e44</u> 8)	0.50	<u>~=</u>	0.020
e1	1.55		0.061	
11	₩.	0.65	1000	0.026

Dimension in mm/inches





DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	73	0.10	47	0.004
у	-0.	0.10	9 <del></del>	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2		0.60	N <del></del>	0.024
e1	2.10		0.083	
11	-25	0.90	-	0.035

Dimension in mm/inches



# **Notice**

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JAPAN	USA	EU	CHINA
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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
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- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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Rev.001

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NSBC114YF3T5G NSBC123TF3T5G SMUN5235T1G SMUN5330DW1T1G SSVMUN5312DW1T2G RN1303(TE85L,F)

RN4605(TE85L,F) TTEPROTOTYPE79 DDTC114EUAQ-7-F EMH15T2R SMUN2214T3G NSBC114TF3T5G NSBC143ZPDP6T5G

NSVMUN5113DW1T3G SMUN5230DW1T1G SMUN5133T1G SMUN2214T1G DTC114EUA-TP NSBA144EF3T5G

NSVDTA114EET1G 2SC2223-T1B-A 2SC3912-TB-E SMUN5237DW1T1G SMUN5213DW1T1G SMUN5114DW1T1G SMUN2111T1G

NSVDTC144EM3T5G DTC124ECA-TP DTC123TM3T5G DTA114ECA-TP DTA113EM3T5G DCX115EK-7-F DTC113EM3T5G

NSVMUN5135DW1T1G NSVMUN2237T1G NSVDTC143ZM3T5G